SIEMENS

Peripheral Board Controller (PBC) PEB 2050

Preliminary Data **MOS IC**

Type	Ordering Code	Package
PEB 2050-C	Q67100-Z157	C-DIP-40
PEB 2050-N	Q67100-H8392	PL-CC-44 (SMD)
PEB 2050-P	Q67100-H3022	P-DIP-40

The peripheral board controller PEB 2050 is a device for the control of voice, data, and signaling paths of up to 16 subscribers on peripheral component boards in digital telephone systems. In combination with the highly flexible Signal Processing Codec Filter (SICOFI® PEB 2060) it forms an optimized analog subscriber-line board architecture. Its flexibility allows operation as general-purpose controller for data switching and MUX/De MUX applications.

The PBC controls space and time switching functions between subscriber-line devices and time-division multiplex highways. Further, it controls the flow of information between the subscriber interface ports and a processor which can be an optional line card local processor or the central processor directly. Last, it performs all protocol control functions, using the HDLC protocol format for all information passing between the line card and the central processor via a dedicated HDLC line or via interleaved time slots on the PCM lines.

To meet the different requirements the PBC PEB 2050 provides the following interfaces:

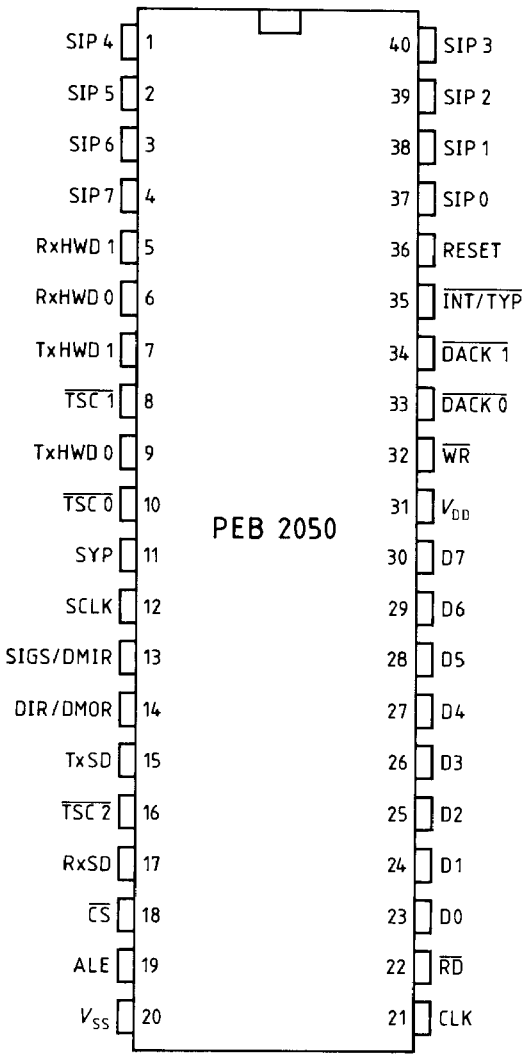
- 8 serial, bidirectional I/O ports for the transfer of voice, data, control, and signaling information between the PBC and codec filters (e.g. SICOFI PEB 2060), digital interface circuits or signal processors
- Double-constructed PCM interface
- Fast serial communication link to the central processor
- Bit-parallel interface for the connection of 8-bit standard microcomputers such as the SAB 8051. The interface is characterized by an interrupt control and two independent DMA channels, one for the transmit and one for the receive direction.

Features

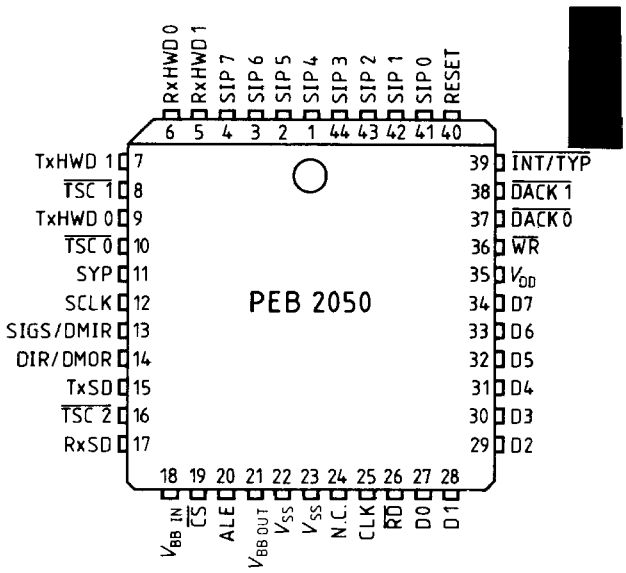
- Board controller for up to 16 subscribers of a digital switching system
- Designed for different PCM systems
- Time-slot assignment freely programmable for all subscribers connected
- Control of voice, data, signaling and line board parameters to minimize hardware requirements and to simplify software
- Provides two full duplex PCM highways for the system interface
- System control uses the HDLC protocol with X.25 level 2 functions performed by the PBC
- Standard µP interface
- Two DMA channels for expansion of internal buffer capability of 16 bytes per direction
- µP access to all internal data streams including time-slot oriented data streams
- Support of subscriber circuits by generating timing signals
- Single +5 V power supply
- Low power consumption

Pin Configuration
(top view)

P-DIP-40
C-DIP-40



PL-CC-44



$V_{BB\ IN}$ and $V_{BB\ OUT}$ Have to be Short Circuited

Pin Definitions and Functions

Pin No. PL-CC	Pin No. P-DIP	Symbol	Name	Function
1 4	1 4	SIP 4 . . . . SIP 7	Subscriber interface port (input/output)	These interface ports are used for bi-directional, bit-serial transfer of speech, data and control words to and from the signal processing codec Filter (SICOFI) or standard codec. Corresponding with the direction signal, the PBC PEB 2050 is transmitting during the high level of DIR within the first half of a 125 µs frame.
5	5	RxHWD 1	Receive highway data (input)	Receive PCM highway 1 interface.
6	6	RxHWD 0	Receive highway data (input)	Receive PCM highway 0 interface. The PBC serially receives a PCM word (8 bits) through one of these leads at the programmed time slot.
7	7	TxHWD 1	Transmit highway data (output)	Output of the transmit side onto the send PCM highway 1 (serial bus). The 8-bit PCM word is serially sent out on this pin at the programmed time slot. Tristate output.
8	8	$\overline{\text{TSC 1}}$	Tristate control (output, active low)	Normally high, this signal goes low while the PBC is transmitting an 8-bit PCM word on the PCM highway 1.
9	9	TxHWD 0	Transmit highway data (output)	Output of the transmit side onto the send PCM highway 0.
10	10	$\overline{\text{TSC 0}}$	Tristate control (output, active low)	Tristate control of highway 0.
11	11	SYP	Synchronization	SYP is a frame synchronization pulse which resets the on-chip time-slot counters.
12	12	SCLK	Slave clock (output)	Clock output for the peripheral devices. The signals between the codec filter and the PBC are latched and transmitted with the rising edge of SCLK.
13	13	SIGS/DMIR	Signal strobe (output, active high)/ direct memory input request (output, active high)	The SIGS output supplies a programmable strobe signal. In the DMA mode, this pin is used as DMA input request.

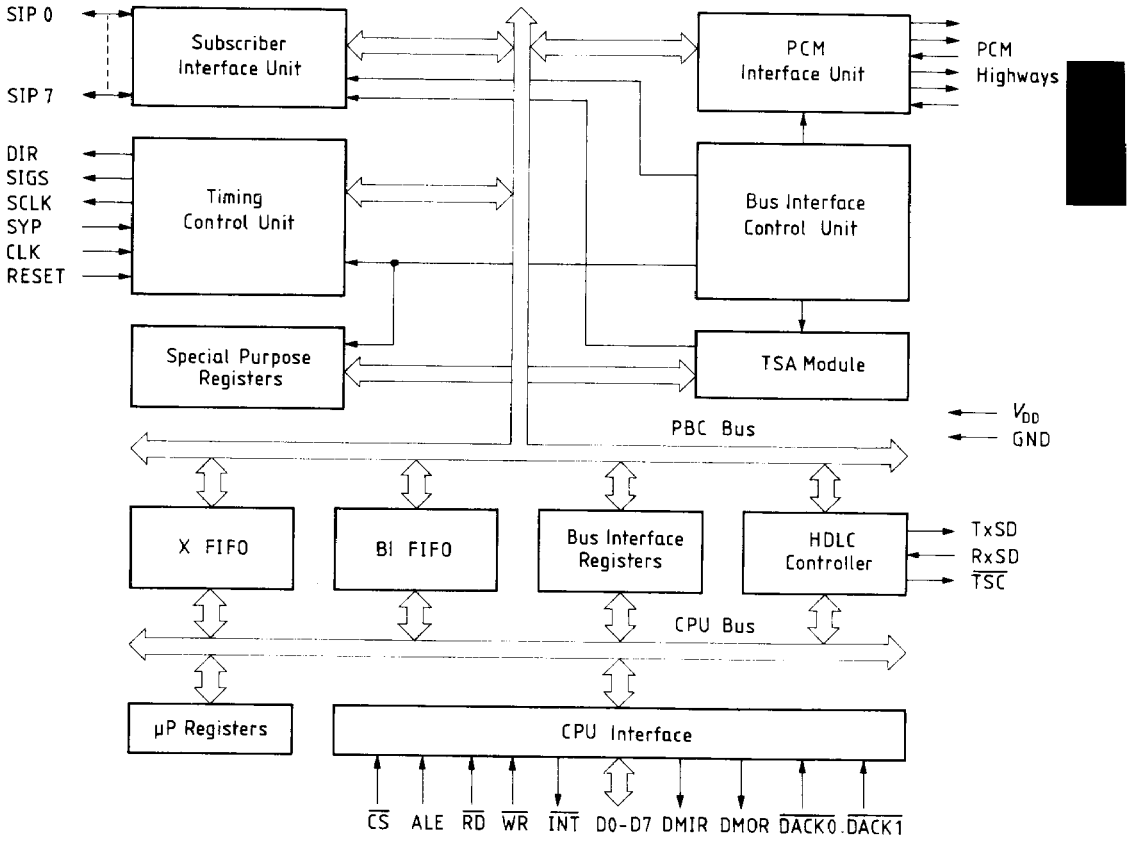
Pin Definitions and Functions (cont'd)

Pin No. PL-CC	Pin No. P-DIP	Symbol	Name	Function
14	14	DIR/DMOR	Direction (output, active high)/direct memory output request (output, active high)	DIR is an 8-kHz symmetric frame signal which controls the direction of data transfer from and to the peripheral devices. The PBC is able to receive data during the low state of DIR. In the DMA mode this pin is used as DMA output request. DMIR and DMOR are generated by the PBC-internal HDLC receiver or transmitter and are used for handshaking during the DMA transfer.
15	15	TxSD	Transmit signaling data (output)	This line transmits the serial data to the dedicated HDLC channel.
16	16	$\overline{\text{TSC 2}}$	Tristate control to 2 (output, active low)	Normally high, this signal goes low while the PBC is transmitting an HDLC message.
17	17	RxSD	Receive signaling data (input)	This line receives the serial data from the HDLC channel.
19	18	$\overline{\text{CS}}$	Chip select (input, active low)	$\overline{\text{CS}}$ is used to address the PBC. A low level at this input enables the PBC to accept commands or data from a µP within a write cycle, or to transmit data during a read cycle.
20	19	ALE	Address latch enable (input, active high)	A high level at this input indicates that the data on the external bus is an address selecting one of the PBC-internal sources or destinations. Latching into the address latch occurs during the high-low transition.
22	20	V_{SS}		Ground (0 V)
25	21	CLK	Clock (input)	A standard TTL clock provides the basic timing of the controller. The clock is synchronous to the PCM clock.
26	22	$\overline{\text{RD}}$	Read strobe (input, active low)	$\overline{\text{RD}}$ is used together with $\overline{\text{CS}}$ to transfer data from the PBC to a µP or memory.

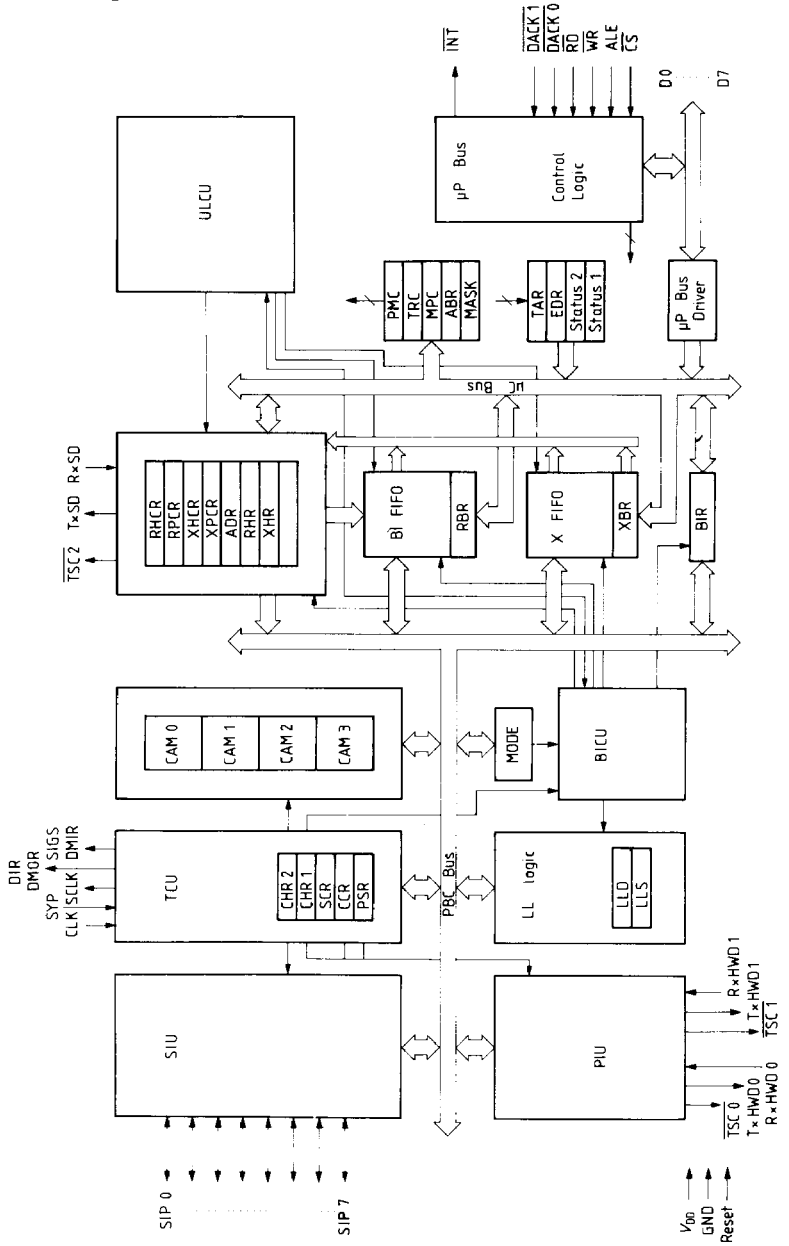
Pin Definitions and Functions (cont'd)

Pin No. PL-CC	Pin No. P-DIP	Symbol	Name	Function
27 34	23 30	D0 . . . . . D7	System data bus	The data bus transfers data and commands between the µP or memory and the PBC.
35	31	V_{DD}		Power supply: $V_{DD} = 5.0 \pm 0.25$ V
36	32	$\overline{WR}$	Write strobe (input, active low)	During the low state of $\overline{WR}$ data can be transferred from the µP or memory to the PBC.
37 38	33 34	$\overline{DACK\ 0}$ $\overline{DACK\ 1}$	DMA acknowledge (inputs, active low)	$\overline{DACK\ 0}$ and $\overline{DACK\ 1}$ are used to acknowledge the DMA output and DMA input request, respectively.
39	35	$\overline{INT/TYP}$	Interrupt request (output, active low)	The signal is pulled down, when the PBC is requesting an interrupt. In that case, the µP should enter an interrupt routine for reading status register 1.
40	36	RESET	Reset (input, active high)	A high on this input forces the PBC into reset state. The minimum reset pulse is 16 complete clock cycles.
41 33	37 40	SIP 0 . . . . . SIP 3		These interface ports are used for bi-directional, bit-serial transfer of speech, data and control words to and from the signal processing codec filter (SICOFI) or standard codec. Corresponding with the direction signal, the PBC PEB 2050 is transmitting during the high level of DIR within the first half of a 125 µs frame.

Block Diagram



Block Diagram



Description of the Functional Blocks

The PBC has been designed especially for use in peripheral subscriber boards, but its functional flexibility also permits its application in various parts of a digital exchange telecommunications system.

Used in peripheral subscriber boards it performs two essential functions:

1) Exchange of control data between a central processing unit, an on-board processing unit and individual subscriber connections. The PBC supports the ISO/CCITT's HDLC communication-line protocol. An application-specific, PBC-internal controller controls the distribution of data on the board.
2) The time-slot controlled transfer of PCM data (64 Kbaud channels) between the PCM highways and the subscriber connections.

Data transfer between both parts, such as signaling through PCM highways (common channel) or the access of the on-board µP to 64 Kbaud channels, are considerably simplified by the IC.

The two central functional blocks are reflected in the circuit structure: The PCM synchronous portion constitutes the interfaces to the subscribers and the PCM highways. It comprises the following functional blocks:

- SIU (Serial Interface Unit) with last look logic
- PIU (PCM Interface Unit)
- CAM (Contents-Addressable Memory)
- TCU (Timing Control Unit)
- MODE register
- PBC bus

The asynchronous portion constitutes the interface to the local microprocessor (8-bit parallel). and to the central control (serial HDLC interface) and comprises the following functional blocks:

- HDLC controller
- µP interface
- µP control and status register
- ULCU (User Level Control Unit)

The two portions are interconnected by the following functional blocks:

- X FIFO (Transmit FIFO)
- Bidirectional FIFO
- BICU (Bus Interface Control Unit)
- BIR (Bus Interface Register)

Maximum Ratings

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Storage temperature	T_{stg}	−65	125	°C

Range of Operation

Operating temperature	T_A	0	70	°C
Voltage at any pin referred to ground	V_S	−0.5	7	V
Total power consumption	P_{tot}		625	mW

DC Characteristics

$T_A = 0$ to 70 °C; $V_{CC} = 5\ V \pm 0.25\ V$; GND = 0 V

Parameter	Symbol	Limit Values			Unit
		min.	typ.	max.	
L-input voltage	V_{IL}	−0.5		0.8	V
H-input voltage	V_{IH}	2.0		5.5	V
L-output voltage $I_{OL} = +1.6$ mA	V_{OL}			0.45	V
H-output voltage $I_{OH} = -400\ \mu A$	V_{OH}	2.4			V
Input leakage current $V_{IN} = V_{CC}$ to 0 V	I_{IL}	−10		10	µA
Output leakage current $V_{OUT} = V_{CC}$ to 0 V	I_{OL}	−10		10	µA
V_{CC} supply current $V_{CC} = 5$ V	I_{CC}		70	125	mA

Capacitance

$T_A = 25\,°C$; $V_{CC} = GND = 0\ V$

Parameter	Symbol	Limit Values			Unit
		min.	typ.	max.	
Input capacitance $f_C = 1$ MHz	C_{IN}		5	10	pF
Input/output capacitance	$C_{I/O}$		10	20	pF
Output capacitance unmeasured pins returned to GND	C_{OUT}		8	15	pF

AC Characteristics

$T_A = 0$ to $70\,°C$; $V_{CC} = 5\ V \pm 0.25\ V$; $GND = 0\ V$

Microprocessor Interface

Read Cycle

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Address hold after ALE	t_{LA}	20		ns
Address to ALE setup	t_{AL}	30		ns
Data delay from $\overline{RD}$	t_{RD}		150	ns
$\overline{RD}$ pulse width	t_{RR}	150	10^7	ns
Output float delay	t_{DF}		25	ns
$\overline{RD}$ control interval case 1[1])	t_{RI}	2 x CP		ns
$\overline{RD}$ control interval case 2[2])	t_{RI}	100		ns
ALE pulse width	t_{AA}	60		ns

Write Cycle

$\overline{WR}$ pulse width	t_{WW}	100		ns
Data setup to $\overline{WR}$	t_{DW}	50		ns
Data hold after $\overline{WR}$	t_{WD}	25		ns
$\overline{WR}$ control interval case 1[1])	t_{WI}	2 x CP		ns
$\overline{WR}$ control interval case 2[2])	t_{WI}	50		ns

[1]) Case 1: read, write of BI FIFO and X FIFO
[2]) Case 2: all other registers

DMA Read

Parameter	Symbol	Limit Values		Unit
		min.	max.	
DMA read time*)	t_{DMA}		7 x CP	ns
DMOR hold time	t_{DH}		75	ns
Address stable before $\overline{RD}$	t_{AR}	0		ns
Data delay from $\overline{RD}$	t_{RD}		150	ns
Output floating delay	t_{DF}		25	ns
Address hold after $\overline{RD}$	t_{RA}	0		ns
$\overline{RD}$ pulse width	t_{RR}	150	10^4	ns

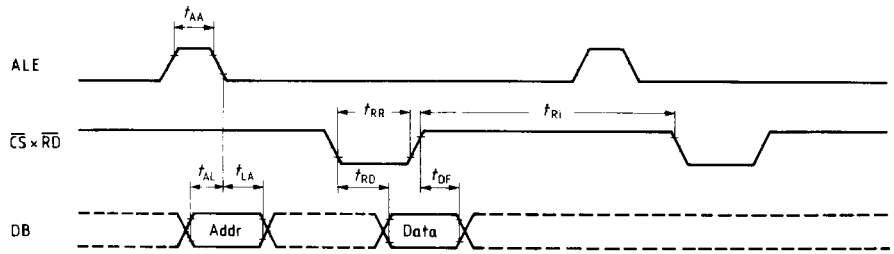
DMA Write

DMA write time*)	t_{DMA}		7 x CP	ns
DMSIR hold time	t_{IH}		90	ns
Address stable before $\overline{WR}$	t_{AW}	0		ns
Address hold after $\overline{WR}$	t_{WA}	0		ns
Data setup to $\overline{WR}$	t_{DW}	50		ns
Data hold after $\overline{WR}$	t_{WD}	25		ns
$\overline{WR}$ pulse width	t_{WW}	100		ns

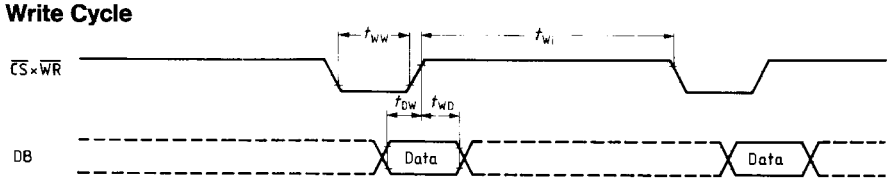
*)

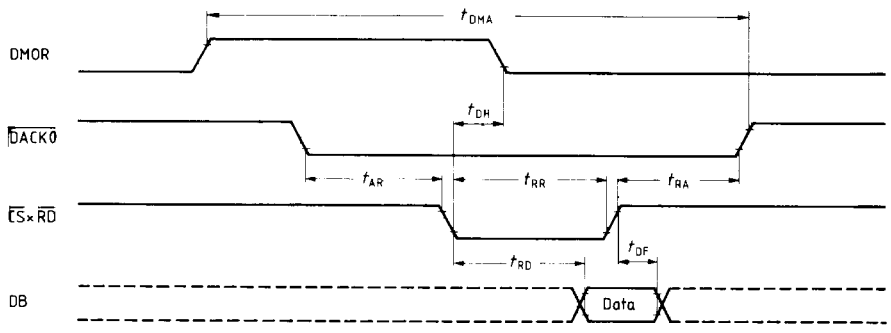
PBC clock/MHz	2.048	4.096	1.536	3.072
2 x CP/ns	980	490	1300	650
7 x CP/µs	3.4	1.7	4.56	2.3

Read Cycle

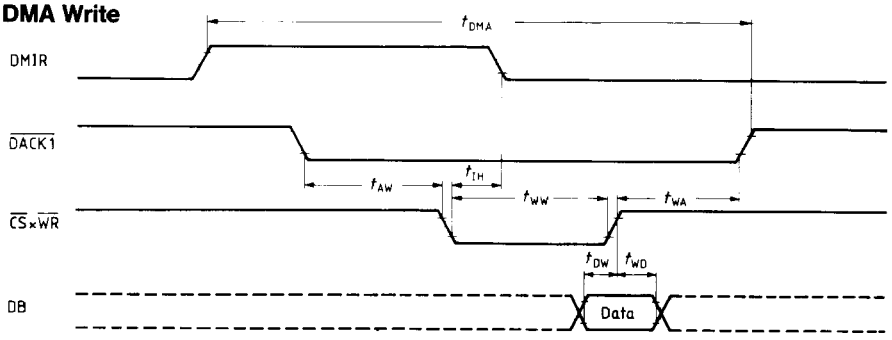


Write Cycle





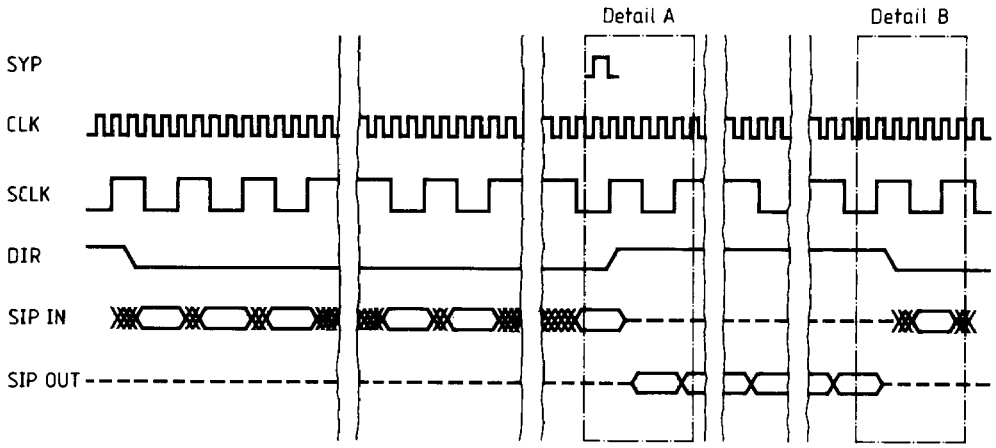
DMA Write

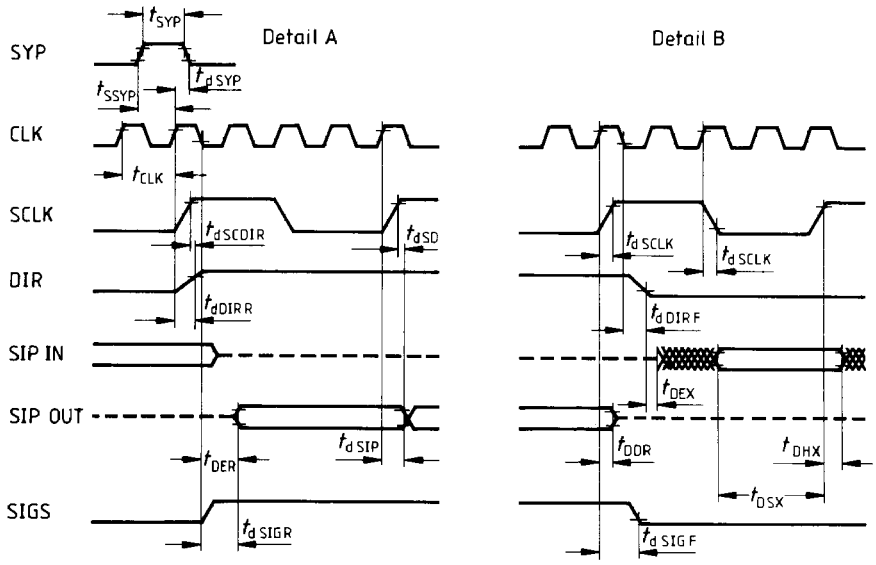


Clock Timing

Parameter	Symbol	Limit Values		Unit
		min.	max.	
System Clock				
System clock frequency	f_{CLK}	1	4.2	MHz
Duty cycle		45	55	%
Sync pulse period	t_{SPP}	125	N x 125	µs
Sync pulse width	t_{SYP}	60	t_{CLK}	ns
Pulse delay to CLK	t_{dSYP}	10		ns
Setup time to CLK	t_{sSYP}	50		ns
Clock rise/fall time	$t_{r\,CLK}$/ $t_{f\,CLK}$		10	ns
Slave Clock				
Clock frequency	f_{SCLK}	512	512	kHz
Clock delay time	t_{dSCLK}	100	165	ns
Delay time SCLK to data	t_{dSD}	20		ns
DIR Clock				
Delay time to CLK (rising edge)	$t_{dDIR\,R}$	120	190	ns
Delay time to CLK (falling edge)	$t_{dDIR\,F}$	30	110	ns
Delay time SCLK to DIR	t_{dSCDIR}	−10	70	ns
SIU Interface				
SIP data delay	t_{dSIP}	160	300	ns
Data enable receive	t_{DER}	100	180	ns
Data disable receive	t_{DDR}	100	180	ns
Data enable transmit	t_{DEX}	0		ns
Data hold transmit	t_{DHX}	0		ns
Data setup transmit (control data)	t_{DSX}	CP/+200		ns
Data setup transmit	t_{DSX}	200		ns
Signaling strobe delay (falling edge)	$t_{DSIG\,F}$	90	200	ns
Signaling strobe delay (rising edge)	$t_{DSIG\,R}$	140	220	ns

SIP Interface Timing



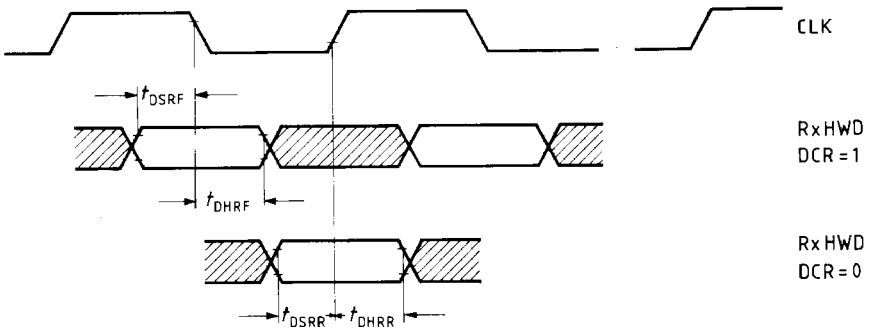


Serial Port Timing

PCM Interface

Parameter	Symbol	Limit Values		Unit
		min.	max.	
Receive Timing				
Receive data setup DCR = 1	t_{DSRF}	20		ns
Receive data setup DCR = 0*	$t_{DS\,RR}$	40		ns
Receive data hold DCR = 1	$t_{DH\,RF}$	40		ns
Receive data hold DCR = 0	$t_{DH\,RR}$	10		ns

Receive Timing

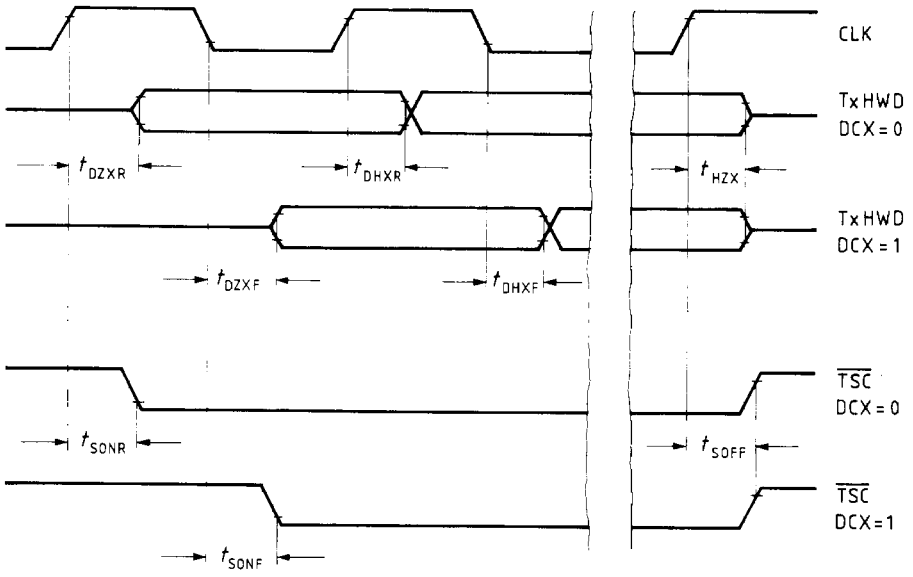


*) Common channel mode t_{DSRR} 75 ns

PCM Interface (cont'd)

Parameter	Symbol	Limit Values min.	Limit Values max.	Unit	Test Conditions
Transmit Timing					
Data enable DCX = 0	t_{DZXR}	80	160	ns	C_L = 200 pF
Data enable DCX = 1	t_{DZXF}	40	100	ns	C_L = 200 pF
Data hold time DCX = 0	t_{DHXR}	45	160	ns	C_L = 200 pF
Data hold time DCX = 1	t_{DHXF}	40	100	ns	C_L = 200 pF
Data float on TS EXIT	t_{HZX}	35	80	ns	C_L = 150 pF
Time slot x to enable DCX = 0	t_{SONR}	70	130	ns	C_L = 150 pF
Time slot x to enable DCX = 1	t_{SONF}	40	100	ns	C_L = 150 pF
Time slot x to disable	t_{SOFF}	40	100	ns	C_L = 150 pF

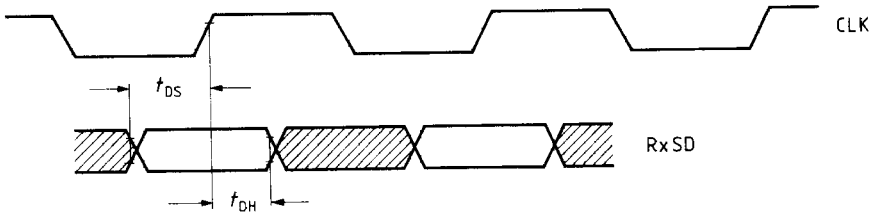
Transmit Timing



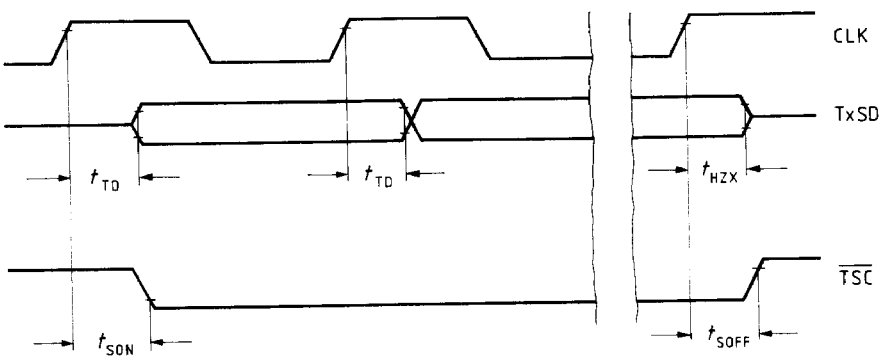
HDLC Interface

Parameter	Symbol	Limit Values		Unit	Test Conditions
		min.	max.		
Receive Timing					
Receive data setup	t_{DS}	40		ns	
Receive data hold	t_{DH}	10		ns	
Transmit Timing					
Transmit data delay	t_{TD}	40	100	ns	$C_L = 200$ pF
Data float on TS EXIT	t_{HZX}	35	80	ns	$C_L = 200$ pF
Time slot x to enable	t_{SON}	40	95	ns	$C_L = 150$ pF
Time slot x to disable	t_{SOFF}	35	90	ns	$C_L = 150$ pF

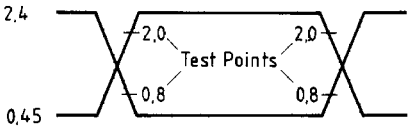
Receive Timing



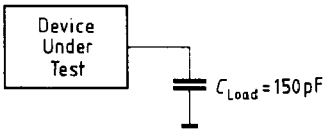
Transmit Timing



AC Testing Input, Output Waveform



AC Testing Load Circuit



AC testing: inputs are driven at 2.4 V for a logic "1" and at 0.45 V for a logic "0".
Timing measurements are made at 2.0 V for a logic "1" and at 0.8 V for a logic "0".